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COVER SHEET
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- ☒ New
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Conveyance Type

- ☒ Assignment
☐ License
☐ Merger
☐ Security Agreement
☐ Change of Name
☐ Other:

Conveying Party(ies)

1. OKUMURA, Kazuhito
2. ANDOU, Hidehiko
- 3.
- 4.
- 5.
- 6.

Execution Date(s)

November 1, 2000
 November 1, 2000

☐ Mark if Additional Names of Conveying Parties Attached**Receiving Party**

Name Nitto Denko Corporation

Name

Address 1-2, Shimohozumi 1-chome

Address

Address Ibaraki-shi

City

Osaka/Japan

State/Country

567-8680

Zip Code

☐ Mark if Additional Names of Receiving Parties Attached**Correspondent Name and Address**

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 Attorney Docket No. 207317

Pages Enter the total number of pages of the attached conveyance document including any attachments: **2****Application Number(s) or Patent Number(s)**☐ Mark if additional numbers attached

Enter either the Patent Application Number or the Patent Number (DO NOT ENTER BOTH numbers for the same property).

Patent Application Numbers**Patent Numbers**

09/709,888

If this document is being filed together with a new Patent Application, enter the date the patent application was signed by the first named executing inventor.

Month Day Year

Patent Cooperation Treaty (PCT)Enter PCT application number *only* if a U.S. Application Number has not been assigned.

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Number of PropertiesEnter the total number of properties involved: **1****Fee Amount**

Fee Amount for Properties Listed (37 CFR 3.41): \$40.00

Method of Payment:

☒ Enclosed is a check in the amount of \$40.00☐ Charge Deposit Account No. 12-1216Authorization to Charge Additional Fees to Deposit Account No. 12-1216: ☒ Yes ☐ No**Statement and Signature**

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charges to deposit account are authorized, as indicated herein.

John Kilyk, Jr., Reg. No. 30,763

Name of Person Signing

Signature

February 8, 2001

Date

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PATENT
REEL: 011517 FRAME: 0984

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Attorneys at Law
Two Prudential Plaza
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180 North Stetson
Chicago, Illinois 60601-6780

ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS, WE,

Kazuhito OKUMURA of c/o Nitto Denko Corporation, 1-2, Shimohozumi 1-chome, Ibaraki-shi,
Osaka 567-8680 Japan

(full name and address, including postal code, of first inventor)

Hidehiko ANDOU of c/o Nitto Denko Corporation, 1-2, Shimohozumi 1-chome, Ibaraki-shi,
Osaka 567-8680 Japan

(full name and address, including postal code, of second inventor)

(full name and address, including postal code, of third inventor)

(full name and address, including postal code, of fourth inventor)

respectively, have invented and own a certain new and useful invention entitled:

**SURFACE PROTECTION FILM FOR LIQUID CRYSTAL DISPLAY, LIQUID CRYSTAL
DISPLAY PROTECTED WITH THE SURFACE PROTECTION FILM AND METHOD OF
PROTECTING LIQUID CRYSTAL DISPLAY WITH THE SURFACE PROTECTION FILM**

for which invention we have executed an application for Letters Patent of the United States which was filed
on November 10, 2000, under Serial No. 09/709,888 ; and

WHEREAS,

Nitto Denko Corporation of 1-2, Shimohozumi 1-chome, Ibaraki-shi, Osaka 567-8680 Japan

(full name and address, including postal code, of assignee)

(hereinafter referred to as Assignee) is desirous of acquiring the entire right, title, and interest in and under the invention described in the application for Letters Patent.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, we have assigned and set over, and by this document do assign and set over, to the Assignee and the Assignee's legal representatives, successors and assigns the entire right, title, and interest in and to the invention in the United States the applications for Letters Patent and other such applications (e.g., continuations, continuations-in-part, divisionals and reissues) in the United States, and the Letters Patent, or extensions thereof, that may or shall issue thereon; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent to the above-mentioned Assignee agreeably with the terms of this Assignment.

WE HEREBY AUTHORIZE the above-mentioned Assignee to insert in this assignment document the filing date and serial number of the application if the date and number are unknown at the time this assignment is executed.

WE DO HEREBY COVENANT and agree with the Assignee that we will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, renewal, reissued, or extended Letters Patent of the United States or of any and all foreign countries on the invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of both parties.

IN WITNESS WHEREOF, we have hereunder set our hands on the dates shown below:

Kazuhito Okumura
Signature of First Inventor Kazuhito OKUMURA

November 1, 2000
Date

Hidehiko Andou
Signature of Second Inventor Hidehiko ANDOU

November 1, 2000
Date

Signature of Third Inventor

Date

Signature of Fourth Inventor

Date

Signature of Fifth Inventor

Date

Signature of Sixth Inventor

Date

Michio Komoto
Witness Michio KOMOTO Date November 1, 2000

Yoshihiro Nobukawa
Witness Yoshihiro NOBUKAWA Date November 1, 2000

Michio Komoto
Witness Michio KOMOTO Date November 1, 2000

Yoshihiro Nobukawa
Witness Yoshihiro NOBUKAWA Date November 1, 2000

Witness Date

Witness Date

Witness Date

Witness Date

Witness Date

Witness Date

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Witness Date